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C1*

a resin fixture intervening between said electrically conductive casing and said semiconductor element module, said resin fixture mounted with said semiconductor element module and fitted to said electrically conductive casing, said resin fixture having a cylinder-shaped section for retaining, in its inner periphery, said column-shaped section of said semiconductor element module, an outer periphery surface of said cylinder-shaped section being metal plated and an inner periphery surface of said cylinder-shaped section not being metal plated.